

DATA SHEET



PCA9558

5-bit multiplexed/1-bit latched 6-bit I²C
EEPROM and octal SMBus registered
interface with 256 byte I²C EEPROM

Product specification

2000 Dec 04

ICL03 — PC Motherboard ICs; Logic Products Group

5-bit multiplexed/1-bit latched 6-bit I²C EEPROM and octal SMBus registered interface with 256 byte I²C EEPROM

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FEATURES

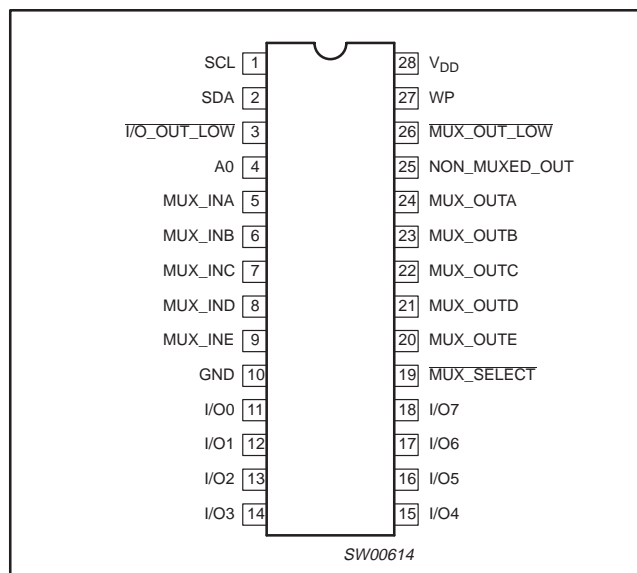
- 5-bit 2-to-1 multiplexer, 1-bit latch
- 6-bit MUX_OUTx and NON_MUXED_OUT EEPROM programmable and readable via I²C-bus
- 5 V tolerant open drain MUX_OUTx and NON_MUXED_OUT outputs
- Active-LOW override input forces all MUX_OUTx outputs to logic 0
- I²C readable MUX_INx inputs
- 5 V tolerant open drain I/Ox pins, power-up default as outputs
- 1 address pin, allowing up to 2 devices on the I²C-bus
- Active-LOW reset input with internal pull-up for the 8 I/O pins
- 2048-bit EEPROM programmable and readable via the I²C or I/Os
- Operating power supply voltage range of 3.0 V – 3.6 V
- SMBus compliance with fixed 3.3 V levels
- 2.5 V – 5 V tolerant inputs
- ESD classification testing is done to JEDEC Standard JESD22. Protection exceeds 2000 V to HBM per method A114.
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA.

DESCRIPTION

The PCA9558 is a multi-function device combining open drain outputs (MUX_OUTx and NON_MUXED_OUT) that are multiplexed between an internal 6-bit EEPROM memory and inputs (MUX_INx), useful for

jumperless motherboard configuration and configured via I²C-bus; 8 open drain General Purpose Input/Output (GPIO) pins, configured via I²C-bus; a 256 byte block of general purpose EEPROM with read/write via I²C or GPIO. The MUX_INx inputs can be read via I²C.

PIN CONFIGURATION



ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DRAWING NUMBER
28-Pin Plastic TSSOP	0 °C to +70 °C	PCA9558DH	SOT361-1

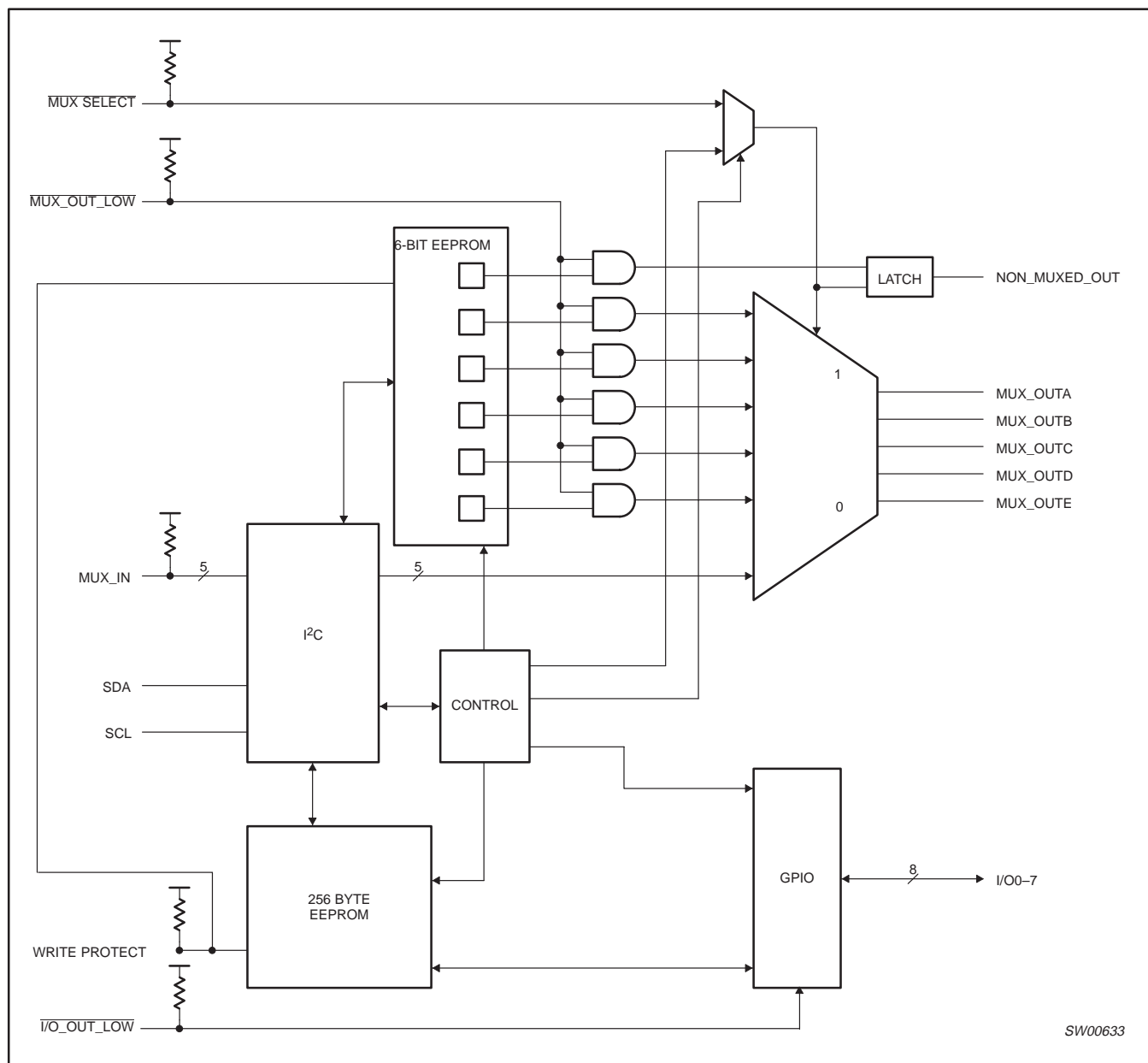
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	SCL	Serial I ² C bus clock
2	SDA	Serial bi-directional I ² C bus data
3	I/O_OUT_LOW	Active-LOW control forces all GPIO to logic 0 outputs
4	A0	A0 Address
5	MUX_IN A	External inputs to multiplexer
6	MUX_IN B	
7	MUX_IN C	
8	MUX_IN D	
9	MUX_IN E	
10	GND	Ground
11–18	I/O[0–7]	Input/Output 0 through 7 (open drain outputs)
19	MUX_SELECT	Active-LOW Select of MUX_IN inputs or EEPROM contents for MUX_OUT outputs
20	MUX_OUT E	Open drain multiplexed outputs
21	MUX_OUT D	
22	MUX_OUT C	
23	MUX_OUT B	
24	MUX_OUT A	
25	NON_MUXED_OUT	Open drain outputs from non-volatile memory
26	MUX_OUT_LOW	Active-LOW control forces all MUX outputs to logic 0
27	WP	Active-HIGH EEPROM write protect
28	V _{DD}	Positive voltage rail

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BLOCK DIAGRAM



5-bit multiplexed/1-bit latched 6-bit I²C EEPROM and octal SMBus registered interface with 256 byte I²C EEPROM

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I²C INTERFACE

Communicating with this device is initiated by sending a valid address on the I²C bus. The address format (see Figure 1) has 6 fixed bits and one user-programmable bits followed by a 1-bit read/write value which determines the direction of the data transfer.

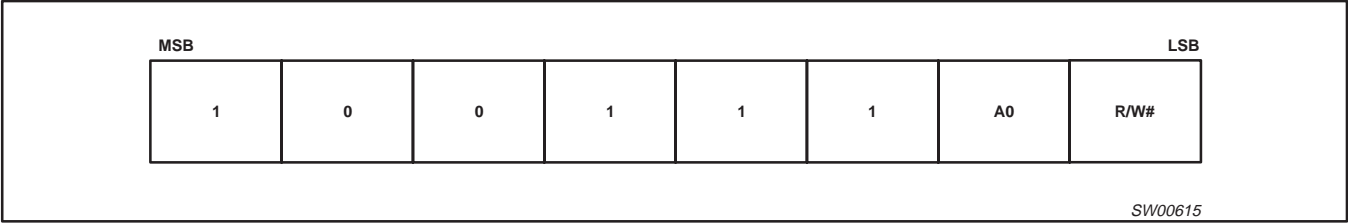


Figure 1. I²C Address Byte

Following the address and acknowledge bit are 8 data bits which, depending on the read/write bit in the address, will read data from or write data to the EEPROM. Data will be written to the register if the read/write bit is logic 0 and the WP input is logic 0. Data will be read from the register if the bit is logic 1. The four high-order bits are latched outputs, while the four low order bits are multiplexed outputs (Figure 3).

NOTE:

1. To ensure data integrity, the EEPROM must be internally write protected when V_{CC} to the I²C bus is powered down or V_{CC} to the component is dropped below normal operating levels.

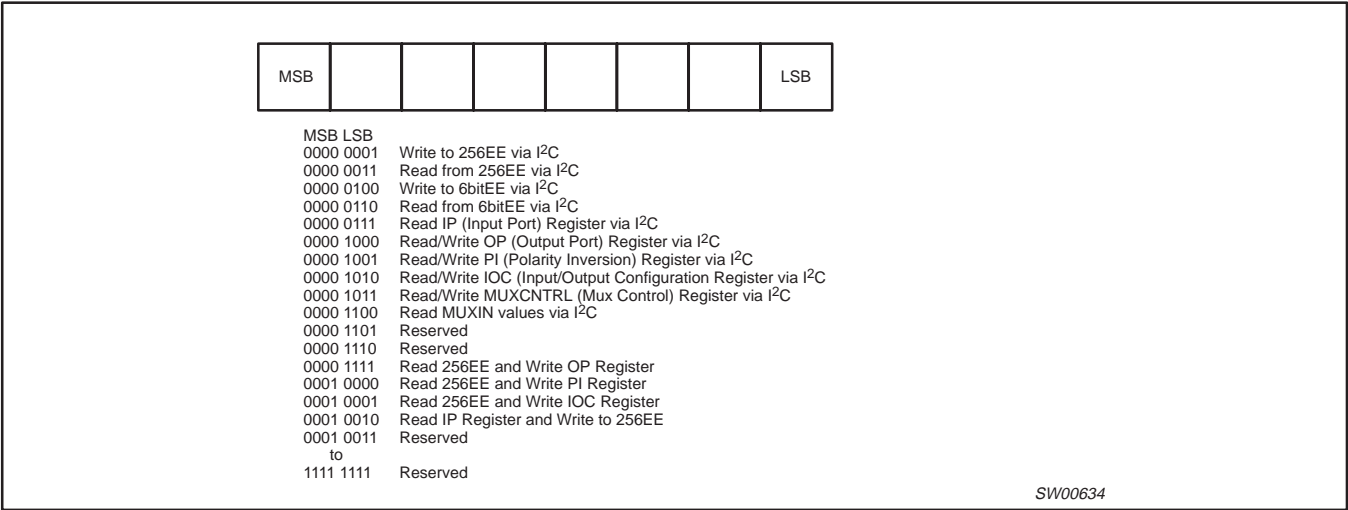


Figure 2. Command Byte

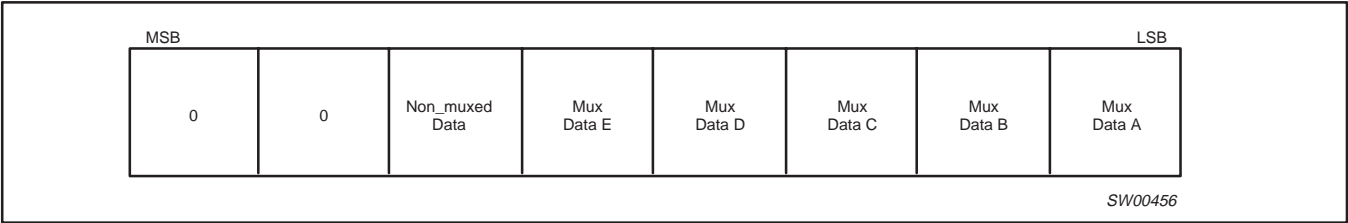


Figure 3. I²C MUX_OUT Data Byte

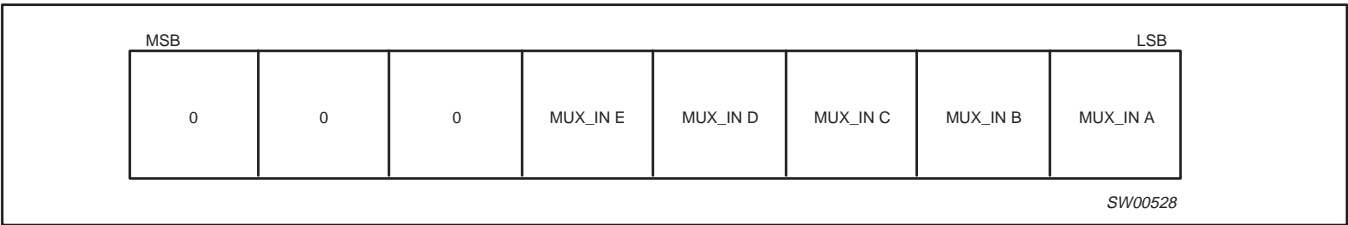


Figure 4. I²C MUX_IN Data Byte

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The Multiplexer function controls the six open drain outputs, MUX_OUTx and NON_MUXED_OUT. This control is effected by the input pins MUX_SELECT (Pin 19), MUX_OUT_LOW (Pin 26), and/or an internal register programmed via the I²C-bus. Upon power-up the multiplex function is controlled by the MUX_SELECT and MUX_OUT_LOW pins. When the MUX_SELECT signal is a logic 0, the multiplexer will select the data from the 6-bit EEPROM to drive on the MUX_OUTx and NON_MUXED_OUT pins. When the MUX_SELECT signal is a logic 1, the multiplexer will select the MUX_INx pins to drive on the MUX_OUTx pins. The NON_MUXED_OUT output is latched from the 6-bit EEPROM on a rising edge of the MUX_SELECT signal. This latch is transparent while the MUX_SELECT signal is a logic 0. An internal control register, written via the I²C bus, can also control the multiplexer function. When this register is written, the MUX_SELECT function can change from the external pin to an internal register. In this register a bit will act in a similar fashion to the MUX_SELECT input, i.e., a logic 1 will cause the multiplexer to select data from the 6-bit EEPROM to drive on the MUX_OUTx and NON_MUXED_OUT pins. In this configuration, the NON_MUXED_OUT will latch data when the PCA9558 acknowledges the I²C-bus. The MUX_SELECT pin will have no effect on the MUX_OUTx or NON_MUXED_OUT while in this mode. When the MUX_OUT_LOW signal is a logic 0 and the multiplexer is configured so that the MUX_OUTx pins are being driven by the 6-bit EEPROM, the MUX_OUTx pins will be driven to a logic 0. This information is summarized in Table 1.

Table 1. Multiplexer function table

REG.		INPUT		OUTPUT	
B1 ³	B0 ³	MUX_OUT_LOW	MUX_SELECT	MUX_OUTx	NON_MUXED_OUT
x	0	0	1	MUX_INx inputs	latched from EEPROM ¹
x	0	0	0	0	0
x	0	1	1	MUX_INx inputs	latched from EEPROM ¹
x	0	1	0	from EEPROM	from EEPROM
0	1	0	x	MUX_INx inputs	latched from EEPROM ²
1	1	0	x	0	0
0	1	1	x	MUX_INx inputs	latched from EEPROM ²
1	1	1	x	from EEPROM	from EEPROM

NOTES:

1. NON_MUXED_OUT value will be the value present in the 6-bit EEPROM at the time of the rising edge of the MUX_SELECT input.
2. NON_MUXED_OUT value will be the value present in the 6-bit EEPROM at the time of the slave ACK when bit1 has changed from 0 to 1.
3. These are the 2LSBs of the MUXCNTRL (Mux Control) Register

If the MUX_OUTx outputs are being driven by the 6-bit EEPROM and this EEPROM is programmed, the outputs will remain stable and change to the new values after the EEPROM program cycle completes.

Examples of Read/Write for MUX control can be found in Figure 5.

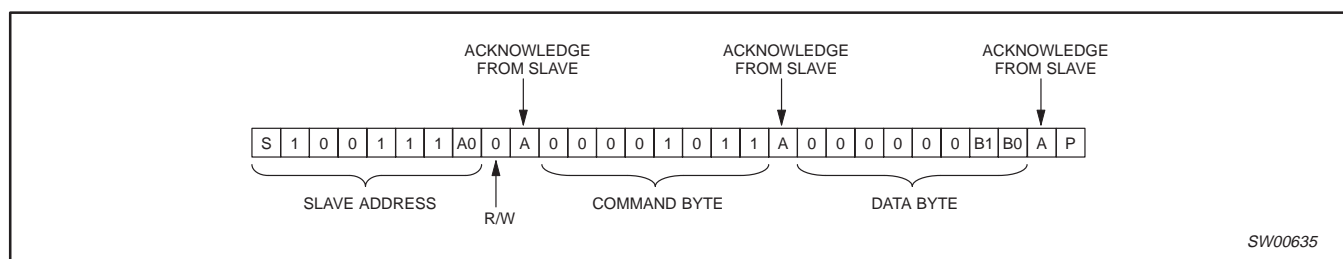


Figure 5. I²C write for MUXCNTRL register

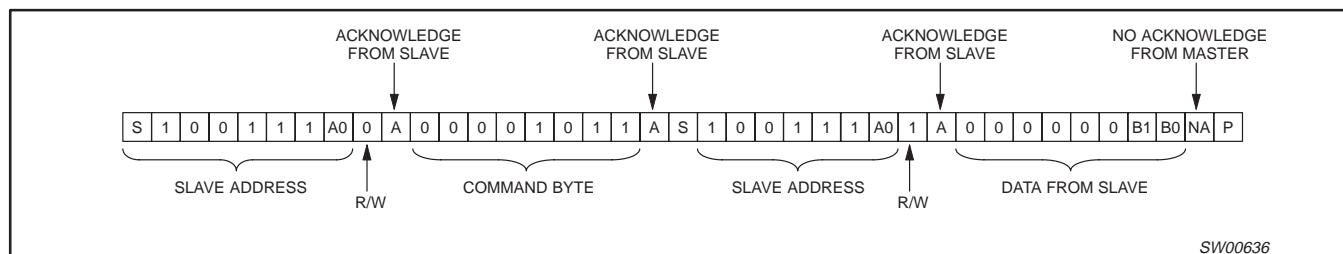


Figure 6. I²C read for MUXCNTRL register

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The GPIOs are controlled by a set of 4 internal registers: Input Port Register (IPR); Output Port Register (OPR); Polarity Inversion Register (PIR); and the Input/Output Configuration Register (IOCR). Each register is read/write via the I²C-bus or 256 byte EEPROM, with the exception of the IPR, which is read only, one at a time. The read/write takes place on the slave ACKNOWLEDGE. The control of which register is currently available to the I²C-bus is set by bits in the control register. See Tables 2 through 5 for details.

Table 2. Input Port Register (IPR)

Bit	I7	I6	I5	I4	I3	I2	I1	I0
Default	0	0	0	0	0	0	0	0

This register is an input-only port. It reflects the logic value present on the GPIO pins regardless of whether they are configured as inputs or outputs (IOCR). Writes to this register have no effect.

Table 3. Output Port Register (OPR)

Bit	O7	O6	O5	O4	O3	O2	O1	O0
Default	0	0	0	0	0	0	0	0

This register is an output-only port. It reflects the outgoing logic levels of the GPIO defined as outputs in the IOCR. Bit values in this register have no effect on GPIO defined as inputs. In turn, reads from this register reflect the value stored in the flip-flop controlling the output, **not** the actual output value.

Table 4. Polarity Inversion Register (PIR)

Bit	P7	P6	P5	P4	P3	P2	P1	P0
Default	1	1	1	1	0	0	0	0

This register enables polarity inversion of GPIO defined as inputs by the IOCR. If a bit in this register is set to a logic 1, the corresponding GPIO input port is inverted. If a bit in this register is set to a logic 0, the corresponding GPIO input port is not inverted.

Table 5. I/O Configuration Register (IOCR)

Bit	C7	C6	C5	C4	C3	C2	C1	C0
Default	0	0	0	0	0	0	0	0

This register configures the direction of the GPIO pins. If a bit is set to a logic 1, the corresponding port pin is enabled as an input with a high impedance output driver. If a bit is set to a logic 0, the corresponding port pin is enabled as an output.

Examples of Read/Write to these registers can be found in Figures 7, 8, 13, and 14.

The $\overline{\text{I/O_OUT_LOW}}$ input, when held LOW longer than the time t_{W} , will reset the GPIO registers to their default (power-up) values.

A read of the present value of the inputs MUX_INx can be done via the I²C. This is done by addressing the PCA9558 in a write mode and entering the correct command code. The preset value on the MUX_INx inputs is latched at the command code ACKNOWLEDGE. A REPEATED START is then sent with the R/W bit set to a logic 1, read, and this latched data is read out on the I²C-bus. See Figure 9.

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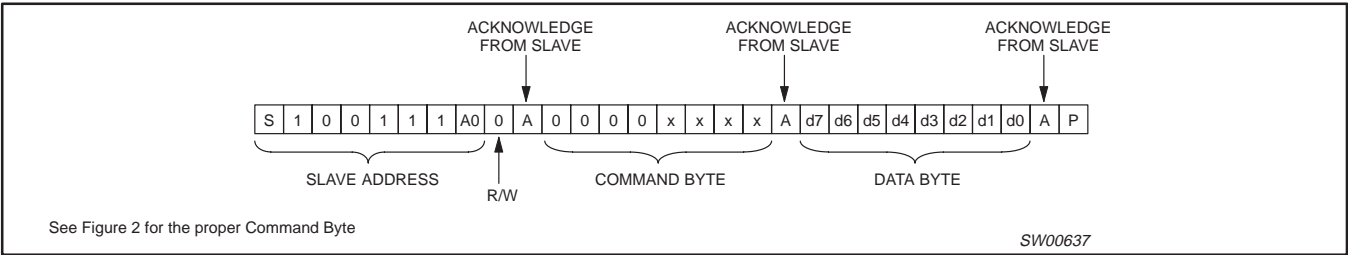


Figure 7. I²C write for GPIO registers

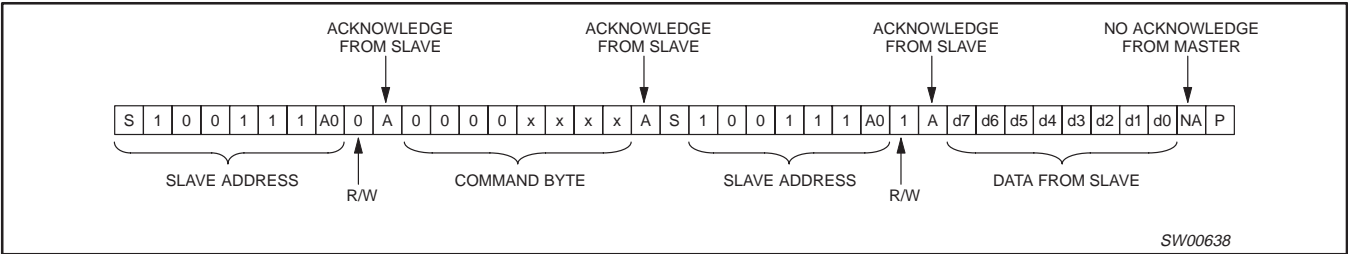


Figure 8. I²C read for GPIO registers

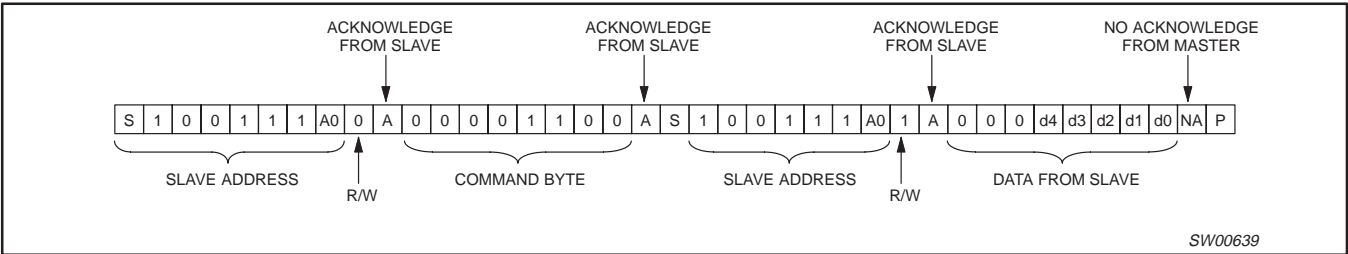


Figure 9. I²C read of MUX_INx inputs

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EEPROM write operation

6-bit write operation

A write operation to the 6-bit EEPROM requires that an address byte be written after the command byte. This address points to the 6-bit address space in the EEPROM array. Upon receipt of this address, the PCA9558 waits for the next byte that will be written to the EEPROM. The master then ends the transaction with a STOP condition on the I²C. See Figure 10.

After the STOP condition, the E/W cycle starts, and the parts will not respond to any request to access the EEPROM array until the cycle finishes, approximately 4 ms.

6-bit read operation

A read operation is initiated in the same manner as a write operation, with the exception that after the word address has been written a REPEATED START condition is placed on the I²C-bus and the direction of communication is reversed (see Figure 11).

256 byte write operation (I²C)

A write operation to the 256 byte EEPROM requires that an address byte be written after the command byte. This address points to the starting address in the EEPROM array. The four LSBs of this address select a position on a 16 byte page register, the 4 MSBs select which page register. The four LSBs will be auto-incremented after receipt of each byte of data; in this manner, the entire page register can be written starting at any point. Up to 16 bytes of data may be sent to the PCA9558, followed by a STOP condition on the I²C-bus. If the master sends more than 16 bytes of data prior to generating a STOP condition, data within the address page will be overwritten and unpredictable results may occur. See Figure 12.

After the STOP condition, the E/W cycle starts, and the parts will not respond to any request to access the EEPROM array until the cycle finishes, approximately 4 ms.

256 byte read operation (I²C)

A read operation is initiated in the same manner as a write operation, with the exception that after the word address has been written, a REPEATED START condition is placed on the I²C-bus, and the direction of communication is reversed. For a read operation, the entire address is incremented after the transmission of each byte, meaning that the entire 256 byte EEPROM array can be read at one time. See Figure 13.

256 byte EEPROM write to GPIO

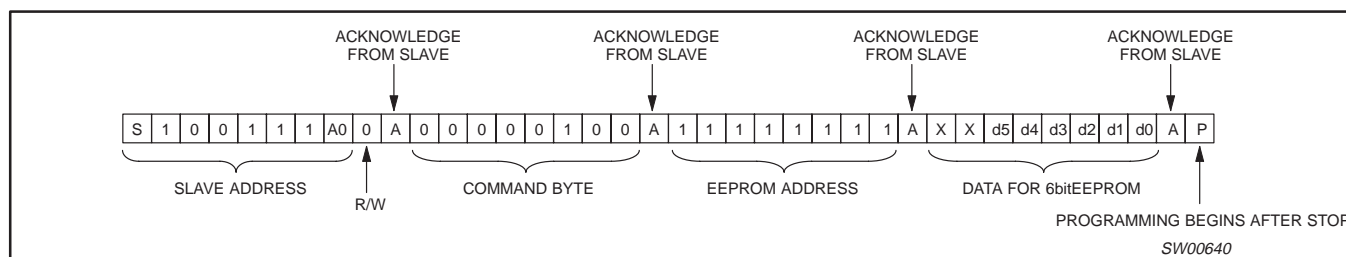
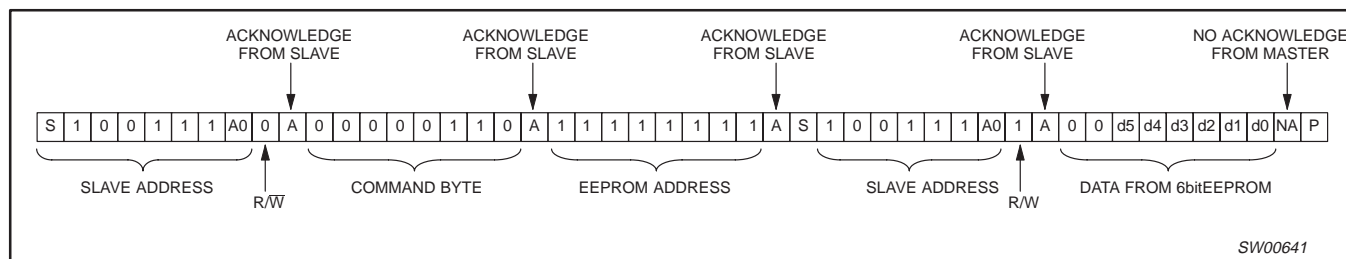
A mode is available whereby a byte of data in the 256 byte EEPROM array can be written to the GPIO (OPR). This is initiated by the I²C-bus. In this mode, a control word indicating a read from the 256 byte EEPROM and write to the GPIO is sent, followed by the word address of the data within the EEPROM array. Upon ACKNOWLEDGE from the slave, the data is sent to the GPIO. See Figure 14.

256 byte EEPROM write from GPIO

A mode is available whereby data in the GPIO (IPR) can be written to the 256 byte EEPROM. This is initiated by the I²C-bus. In this mode, a control word indicating a read from the GPIO and write to the 256 byte EEPROM is sent, followed by the word address for the data to be written. Once the slave sent an ACKNOWLEDGE, the master must send a STOP condition. See Figure 15.

After the STOP condition, the E/W cycle starts, and the parts will not respond to any request to access the EEPROM array until the cycle finishes, approximately 4 ms.

When the Write Protect (WP) input is a logic 0 it allows writes to both EEPROM arrays. When a logic 1, it prevents any writes to the EEPROM arrays.

Figure 10. I²C write of 6-bit EEPROMFigure 11. I²C read of 6-bit EEPROM

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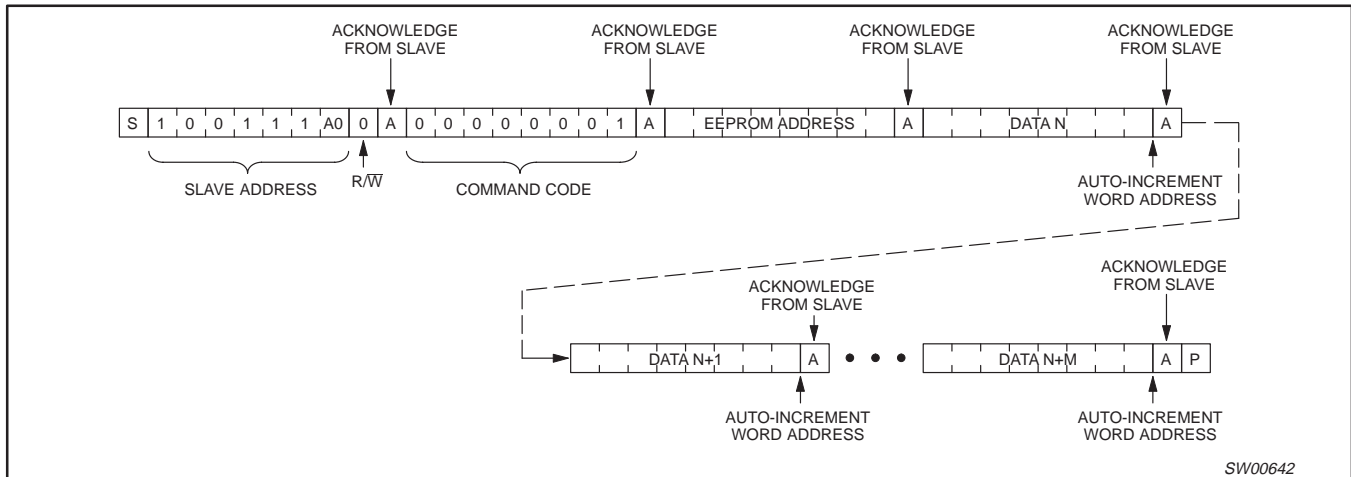


Figure 12. I²C page write operation to 256 byte EEPROM; M bytes where $M \leq 15$

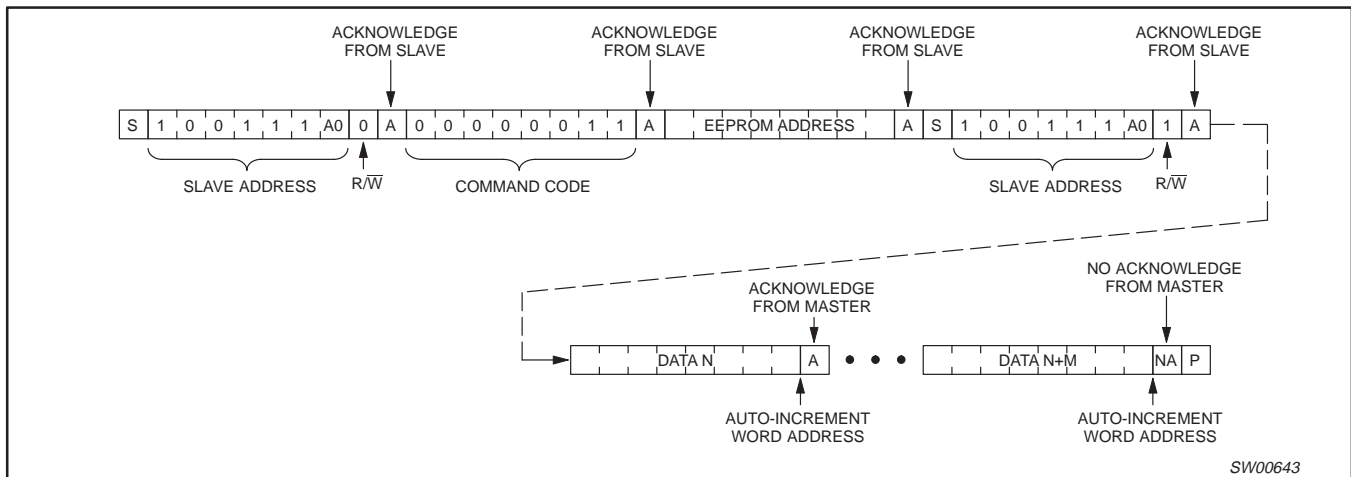


Figure 13. I²C read operation from 256 byte EEPROM; M bytes where $M \geq 1$

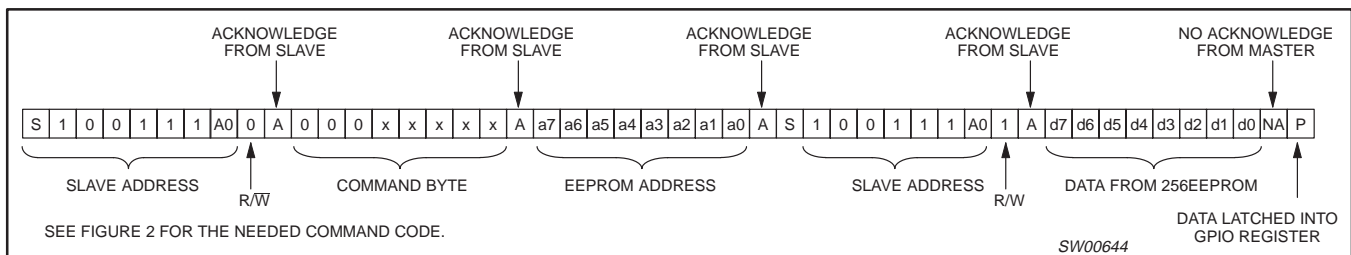


Figure 14. Read from 256 byte EEPROM and write to GPIO registers

5-bit multiplexed/1-bit latched 6-bit I²C EEPROM and octal SMBus registered interface with 256 byte I²C EEPROM

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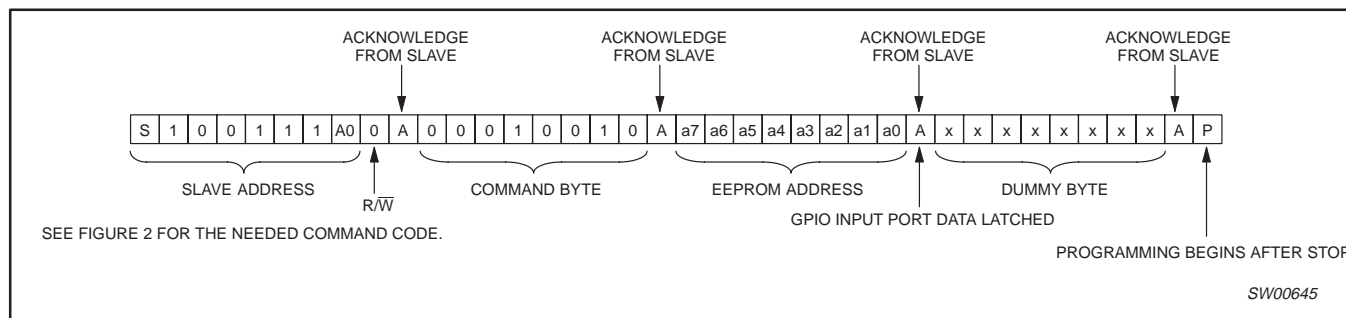


Figure 15. Read from GPIO Input Port Register and write to 256 byte EEPROM

RESET

Power-on Reset

When power is applied to V_{DD} , an internal power-on reset holds the PCA9558 in a reset state until V_{DD} has reached V_{POR} . At that point, the reset condition is released and the PCA9558 registers and SMBus state machine will initialize to their default states.

External Reset

A reset of the GPIO registers can be accomplished by holding the $\overline{I/O_OUT_LOW}$ pin low for a minimum of T_w . These GPIO registers return to their default states until the $\overline{I/O_OUT_LOW}$ input is once again high.

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134)

Voltages are referenced to GND (ground = 0 V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{DD}	DC supply voltage		2.5 to 4.6	V
V _I	DC input voltage	Note 3	−0.5 to V _{CC} +0.5	V
V _{OUT}	DC output voltage	Note 3	−0.5 to V _{CC} +0.5	V
T _{stg}	Storage temperature range		−60 to +150	°C

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIMITS		UNIT
			MIN	MAX	
V _{DD}	DC supply voltage		3	3.6	V
SCL, SDA	V _{IL}	I _{OL} = 3 mA	−0.5	0.9	V
	V _{IH}	I _{OL} = 3 mA	2.7	4.0	V
	V _{OL}	I _{OL} = 3 mA		0.4	V
	V _{OL}	I _{OL} = 6 mA		0.6	V
MUX_OUT_LOW, MUX_IN, MUX_SELECT	V _{IL}		−0.5	0.8	V
	V _{IH}		2.0	4.0	V
MUX_OUT, NON_MUXED_OUT	I _{OL}	V _{OL} = 0.4 V		4	mA
	I _{OH}			100	μA
dt/dv	Input transition rise or fall time		0	10	ns/V
T _{amb}	Operating temperature		0	+70	°C

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DC CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS			UNIT
			MIN.	TYP.	MAX.	
Supply						
V _{DD}	Supply Voltage		3.0		3.6	V
I _{CCL}	Supply Current	Operating mode ALL inputs = 0 V			10	mA
I _{CCH}	Supply Current	Operating mode ALL inputs = V _{DD}			10	mA
Input SCL: Input/Output SDA						
V _{IL}	Low Level Input Voltage		−0.5		0.8	V
V _{IH}	High Level Input Voltage		2		V _{CC} + 0.5	V
I _{OL}	Low Level Output Current	V _{OL} = 0.4	3			mA
I _{OL}	Low Level Output Current	V _{OL} = 0.6	6			mA
I _{IH}	Leakage Current High	V _I = V _{DD}	−1		1	μA
I _{IL}	Leakage Current Low	V _I = GND	−1		1	μA
C _I	Input Capacitance				10	pF
MUX_OUT_LOW, WP, MUX_SELECT						
I _{IH}	Leakage Current High	V _I = V _{DD}			1	μA
I _{IL}	Leakage Current Low	V _I = GND			−100	μA
C _I	Input Capacitance				10	pF
Mux A → E						
I _{IH}	Leakage Current High	V _I = V _{DD}			1	μA
I _{IL}	Leakage Current Low	V _I = GND			−100	μA
C _I	Input Capacitance				10	pF
A0 Inputs						
I _{IH}	Leakage Current High	V _I = V _{DD}			1	μA
I _{IL}	Leakage Current Low	V _I = GND			−100	μA
C _I	Input Capacitance				10	pF
MUX_OUTx						
V _{OL}	Low Level Output Current	(I _{OL} = 100 μA)			0.4	V
V _{OL}	Low Level Output Current	(I _{OL} = 4 mA)			0.7	V
I _{OH}	High Level Output Current	(V _{OH} = V _{DD})			100	μA
NON_MUXED OUT						
V _{OL}	Low Level Output Current	(I _{OL} = 100 μA)			0.4	V
V _{OL}	Low Level Output Current	(I _{OL} = 4 mA)			0.7	V
I _{OH}	High Level Output Current	(V _{OH} = V _{DD})			100	μA
GPIO						
V _{OL}	Low Level Output Current	(I _{OL} = 100 μA)			0.4	V
V _{OL}	Low Level Output Current	(I _{OL} = 4 mA)			0.7	V
I _{OH}	High Level Output Current	(V _{OH} = V _{DD})			100	μA

NOTE:

1. V_{HYS} is the hysteresis of Schmitt-Trigger inputs

NON-VOLATILE STORAGE SPECIFICATIONS

PARAMETER	SPECIFICATION
Memory cell data retention	10 years min
Number of memory cell write cycles	3,000 cycles min

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AC CHARACTERISTICS

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN.	TYP.	MAX.	
MUX_INx ⇒ MUX_OUTx					
t _{PLH}			21	28	ns
t _{PHL}			7	10	ns
MUX_SELECT ⇒ MUX_OUTx					
t _{PLH}			20	28	ns
t _{PHL}			8	12	ns
MUX_OUT_LOW ⇒ NON_MUXED_OUT					
t _{PLH}			20	26	ns
t _{PHL}			8	15	ns
MUX_OUT_LOW ⇒ MUX_OUTx					
t _{PLH}			20	28	ns
t _{PHL}			7.0	15	ns
t _R	Output rise time	1.0		10	ns/V
t _F	Output fall time	1.0		5	ns/V
C _L	Test load capacitance on outputs				pF
I ² C Bus					
t _{SCL}	SCL clock frequency	10		400	kHz
t _{BUF}	Bus free time between a STOP and a START condition	1.3			μs
t _{HD:STA}	Hold time (repeated) START condition. After this period, the first clock pulse is generated	600			ns
t _{LOW}	LOW period of SCL clock	1.3			μs
t _{HIGH}	HIGH period of SCL clock	600		−12	ns
t _{SU:STA}	Set-up time for a repeated START condition	600		−32	ns
t _{HD:DAT}	Data hold time	0		10	ns
t _{SU:DAT}	Data set-up time	100		−100	ns
t _{SP}	Data spike time	0		50	ns
t _{SU:STO}	Set-up time for STOP condition	600		10	ns
t _R	Rise time for both SDA and SCL signals (10 – 400 pF bus)	20		300	ns
t _f	Fall time for both SDA and SCL signals (10 – 400 pF bus)	20		300	ns
C _L	Capacitive load for each bus line			400	pF
T _W	Write cycle time ¹		15		mS

NOTE:

1. WRITE CYCLE time can only be measured indirectly during the write cycle. During this time, the device will not acknowledge its I²C Address.

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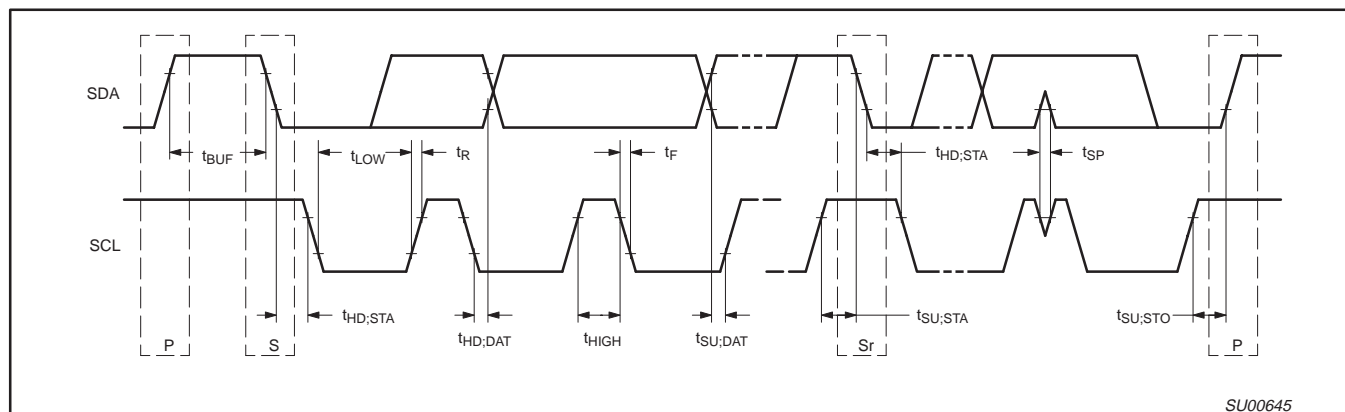


Figure 16.

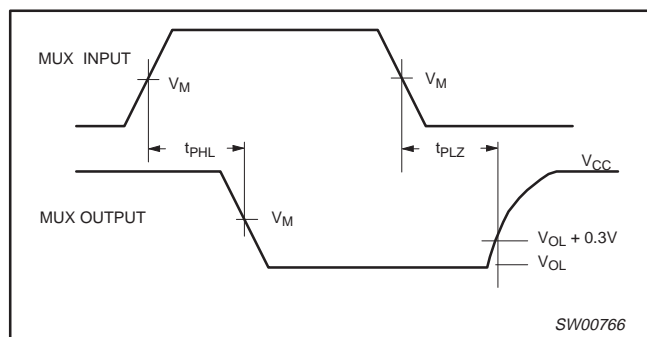


Figure 17. Open drain output enable and disable times

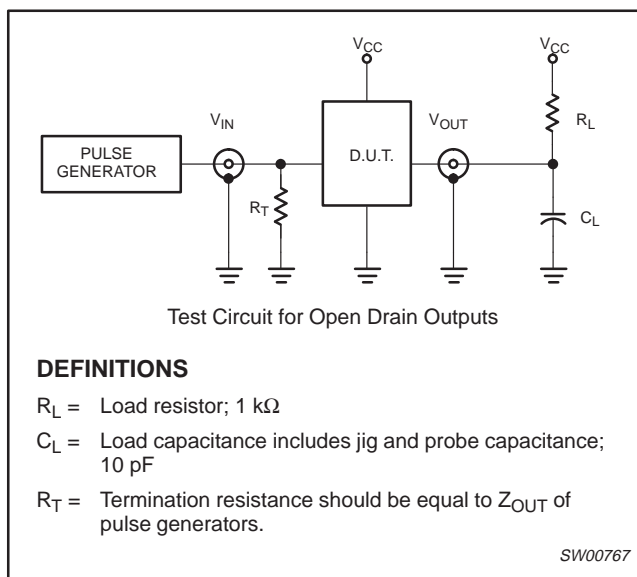


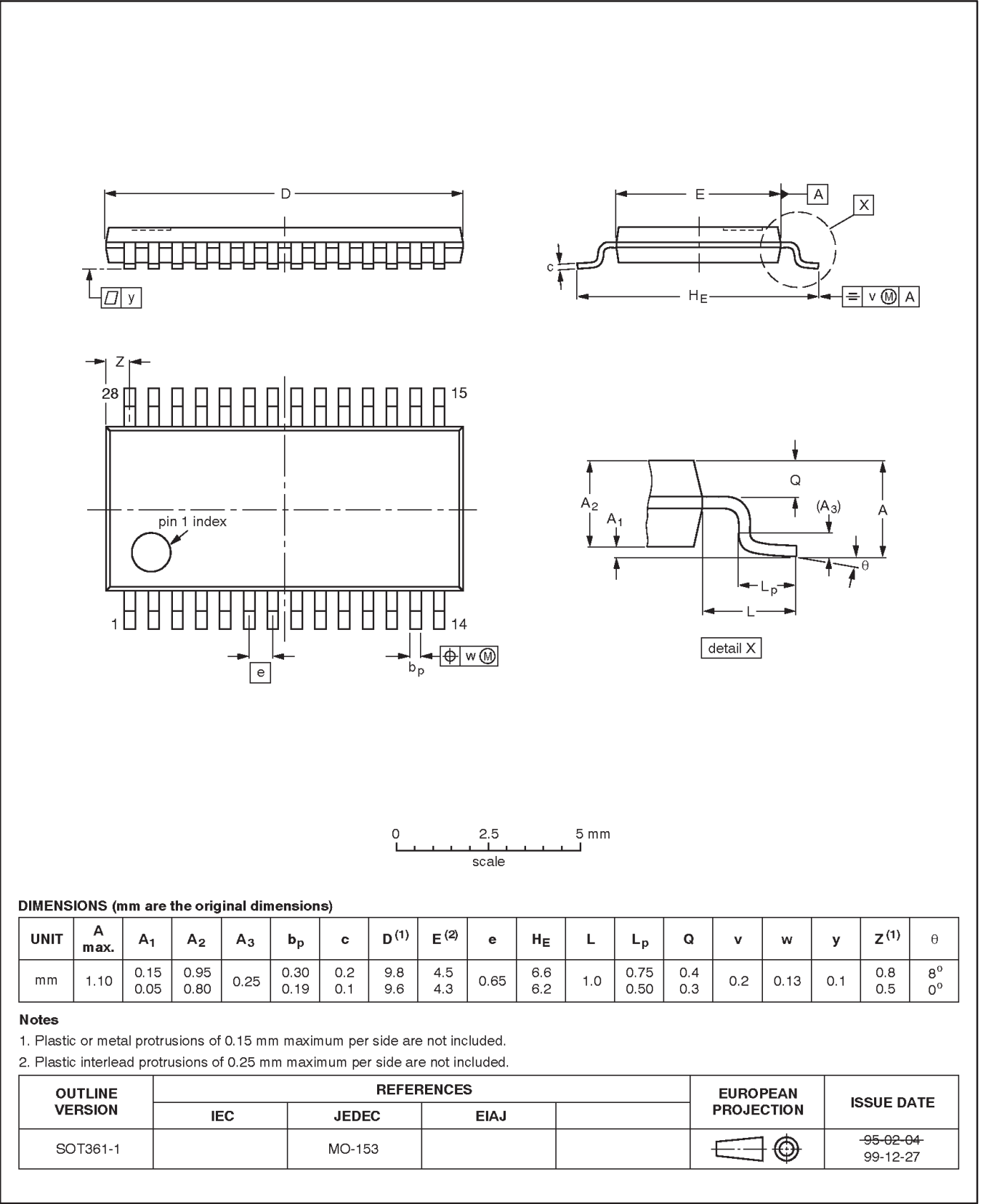
Figure 18. Test circuit

5-bit multiplexed/1-bit latched 6-bit I²C EEPROM and octal SMBus registered interface with 256 byte I²C EEPROM

PCA9558

TSSOP28: plastic thin shrink small outline package; 28 leads; body width 4.4 mm

SOT361-1



5-bit multiplexed/1-bit latched 6-bit I²C EEPROM and octal SMBus registered interface with 256 byte I²C EEPROM

PCA9558



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Date of release: 12-00

Document order number:

9397 750 07868

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